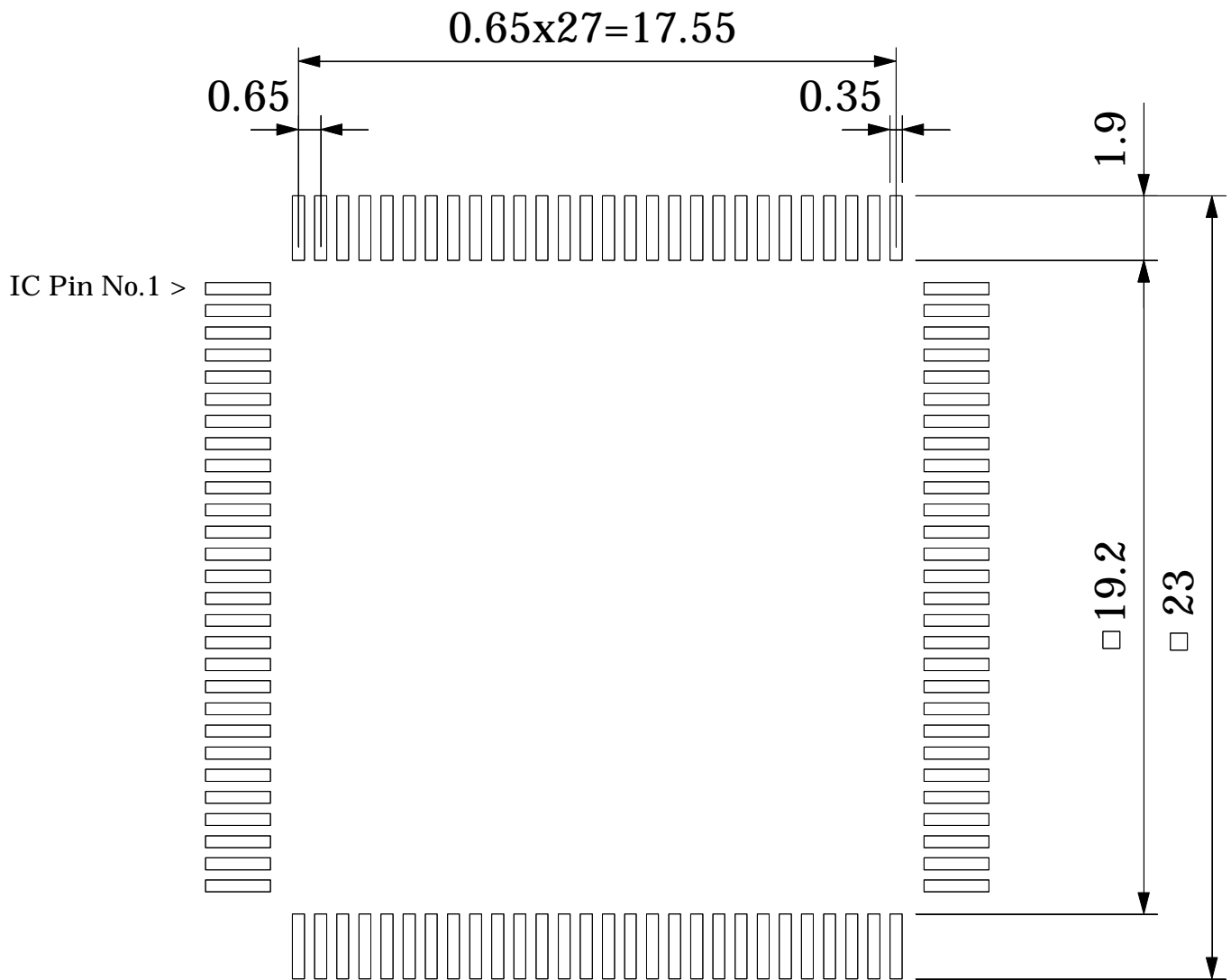


BOTTOM VIEW

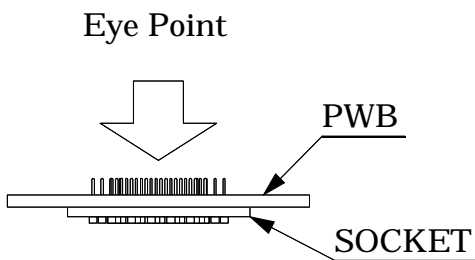
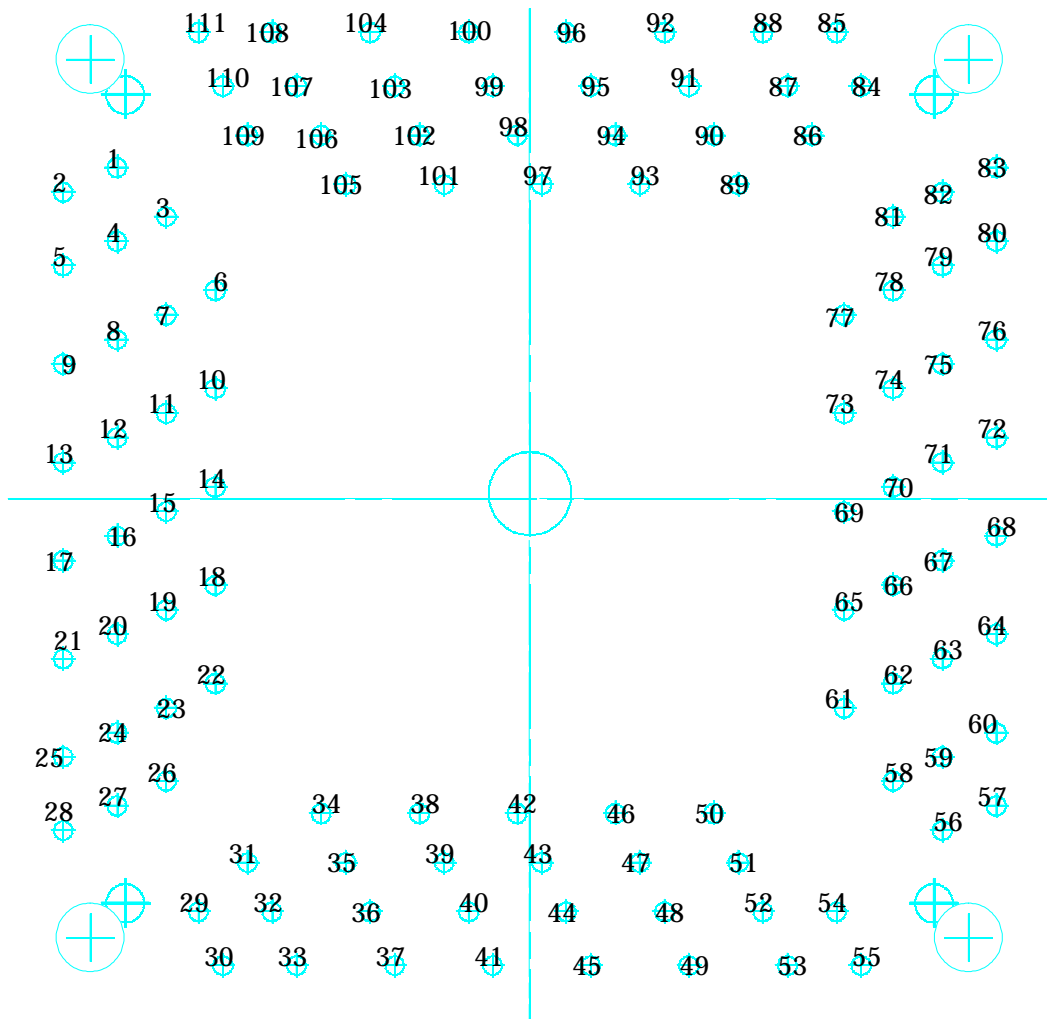
Part No.	TQPACK112SB	
IC package	Square	
Pin count	112Pin	
Lead pitch	0.65mm	
Unit : mm	Design : M.H	
TET TOKYO ELETECH CORP.		

Recommended a Footprint pattern of TQPACK112SB



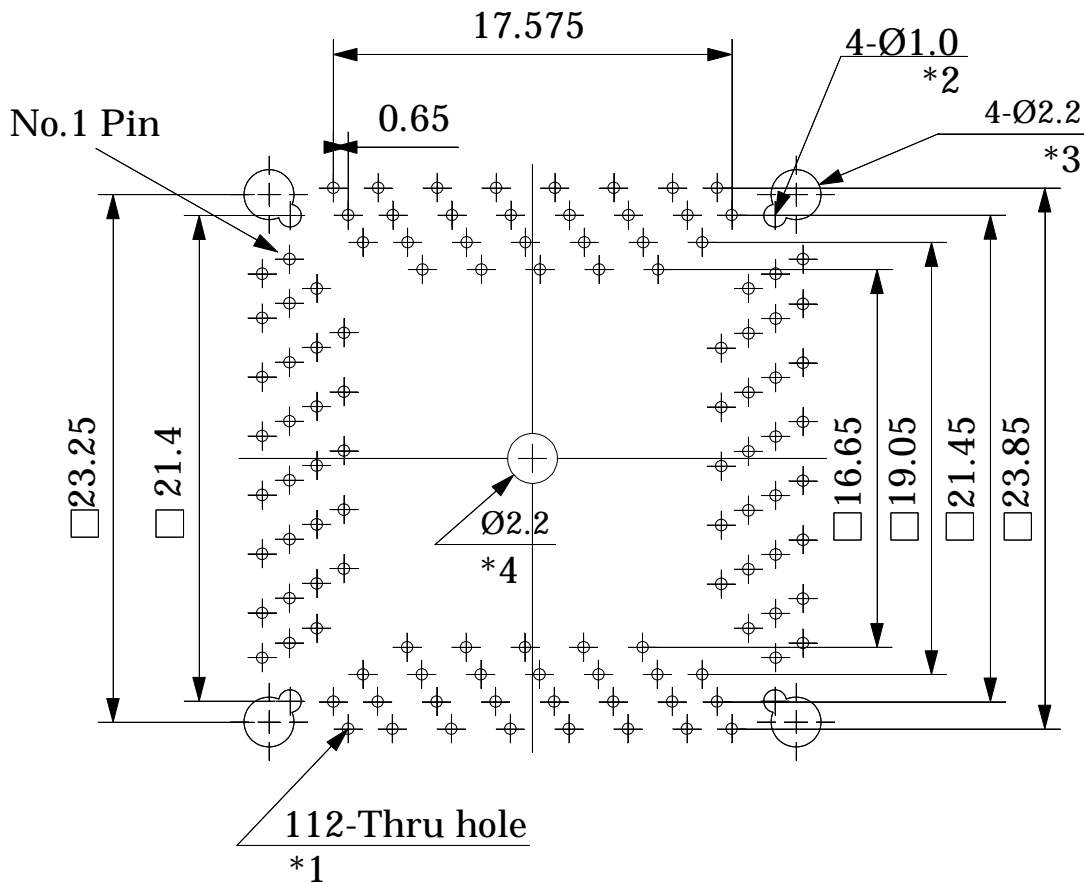
Part No.	TQPACK112SB
IC package	Square
Pin count	112Pin
Lead pitch	0.65mm
Unit : mm	Design : M.H
TET TOKYO ELETECH CORP.	

Recommended a PWB layout of TQSOCKET/YQSOCKET112SB Series




Part No.	TQ/YQSOKET112SB	
IC package	Square	
Pin count	112	
Unit : mm	Design : M.H	
TET TOKYO ELETECH CORP.		

Recommended a PWB layout of TQSOCKET/YQSOCKET112SB Series



NOTES:

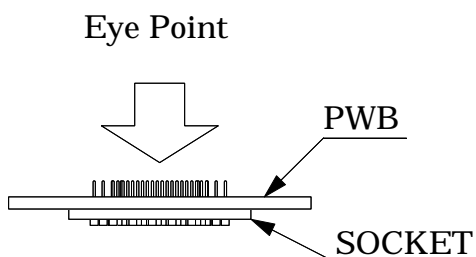
*1  mark is through hole.

The diameter is 0.5mm after plating copper on the hole.

*2 TQSOCKET guide pin hole and location.

*3 YQSOCKET guide pin hole and location.

*4 Screw hole and location for fastening TQSOCKET.



Part No.	TQ/YQ112SB	
IC package	Square	
Pin count	112Pin	
Lead pitch	0.65mm	
Unit : mm	Design : M.H	
TET TOKYO ELETECH CORP.		